

# **Product Compliance Declaration**

Please see <a href="https://www.molex.com">www.molex.com</a> for the most up-to-date information.

**Contact Information** 

Name Molex Product Compliance E-Mail Product.Compliance@molex.com

**Part Information** 

Part Number 0353130960 Part Weight 2.502G

Part Name 3.96 PITCH W/B CONN WAFER ASSY

# **Product Composition**

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
3.96 PITCH W/B CONN WAFER ASSY	Assembly		100	2.502
3.96 PITCH W/B CONN WAFER	Component		59.3525	1.485
PA66-GF20	Material		59.3525	1.485
PA66	Substance		32.0504	0.8019
GF-Fibre	Substance		11.8705	0.297
Flame Retardant, ISO 1043-4 FR(17)	Substance		10.0899	0.25245
Antimonytrioxide	Substance	1309-64-4	4.1547	0.10395
Further Additives, not to declare	Substance	system	1.1871	0.0297
1.07SQ WIRE PIN PLATED	Assembly		40.6475	1.017
1.07 SQ WIRE PIN	Assembly		39.5683	0.99
1.07 SQ WIRE PIN	Component		39.5683	0.99
C2700	Material		39.5683	0.99
Copper	Substance	7440-50-8	25.7194	0.6435

#### Form Rev - F

Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Zinc (metal)	Substance	7440-66-6	13.8291	0.346005
Lead	Substance	7439-92-1	0.0099	0.000248
Iron	Substance	7439-89-6	0.0099	0.000248
Copper Plating	Material		0.5396	0.0135
Copper	Substance	7440-50-8	0.5396	0.0135
Tin Plating	Material		0.5396	0.0135
Tin	Substance	7440-31-5	0.5396	0.0135

# **ROHS Declaration Information**

**Regulatory Revision** EU 2015/863

Compliance Status Compliant

**Contained Substances Exceeding Threshold** 

None

**Exemptions** 

None

# **REACH-SVHC Declaration Information**

**Regulatory Revision** D(2020)4578-DC (25 June 2020)

**Contained Substances Exceeding Threshold** 

None

## **GADSL Declaration Information**

Regulatory Revision GADSL imported from IMDS

#### **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
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Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
lead		*Note	500	Yes
lead	C2700	*Note	250	Yes
Antimonytrioxide	PA66-GF20	*Note	70,000	Yes
copper	C2700	*Note	650,000	Yes
copper	e-plate Cu (electrodeposited Copper Coatings)	*Note	999,625	Yes
glass, oxide, chemicals	PA66-GF20	*Note	200,000	Yes

<sup>\*</sup>Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

## **Exemptions**

Part Name Exemption	
44 Concentration within acceptable GADSL limits	
C2700 44 Concentration within acceptable GADSL limits	

## **HFLH Declaration Information**

Regulatory Revision IEC 61249-2-21

# **Contained Substances Exceeding Threshold**

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Bromine and Chlorine combined	PA66-GF20	1,500	170,000	Yes
Bromine and its compounds	PA66-GF20	900	170,000	Yes

## **China ROHS Declaration Information**

Part Number	0353130960							
Part Name	3.96 PITCH W/B CONN WAFER ASSY	<del>(e)</del>						
Part Informatio	on			Haz	zardous S	Substance	es	
Components			Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
3.96 PITCH V	V/B CONN WAFER ASSY		0	0	0	0	0	0

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Components	Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
3.96 PITCH W/B CONN WAFER	0	0	0	0	0	0
1.07SQ WIRE PIN PLATED	0	0	0	0	0	0
1.07 SQ WIRE PIN	0	0	0	0	0	0
1.07 SQ WIRE PIN	0	0	0	0	0	0

## **Process Information**

Component Plating / Surface Finish	SnCu
Termination Base Alloy	Brass
Solder Alloy	SnAgCu
Process Capability	N/A
Maximum Exposure Time (seconds)	N/A
Maximum Process Temperature (C)	N/A
Maximum Cycles at Reflow Temperature	N/A
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021